Silicon P Channel Power MOS FET High Speed Power Switching

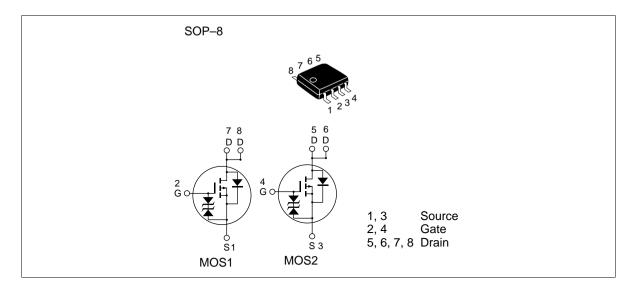
HITACHI

ADE-208-522 (Z) 1st. Edition May 1997

Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

Outline





Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

| ltem | Symbol | Ratings | Unit |
|--|-------------------|-------------|------|
| Drain to source voltage | V _{DSS} | -20 | V |
| Gate to source voltage | V _{GSS} | ±10 | V |
| Drain current | I _D | -3.5 | A |
| Drain peak current | Note1 D(pulse) | -28 | A |
| Body-drain diode reverse drain current | I _{DR} | -3.5 | A |
| Channel dissipation | Pch Note2 | 2 | W |
| Channel dissipation | Pch Note3 | 3 | W |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

Note: 1. $PW \le 10\mu s$, duty cycle $\le 1 \%$

2. 1 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW≤ 10s

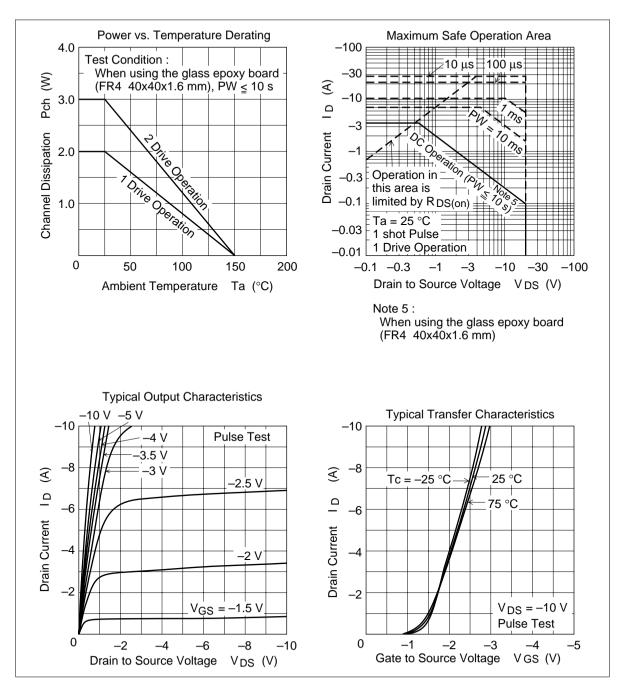
3. 2 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW≤ 10s

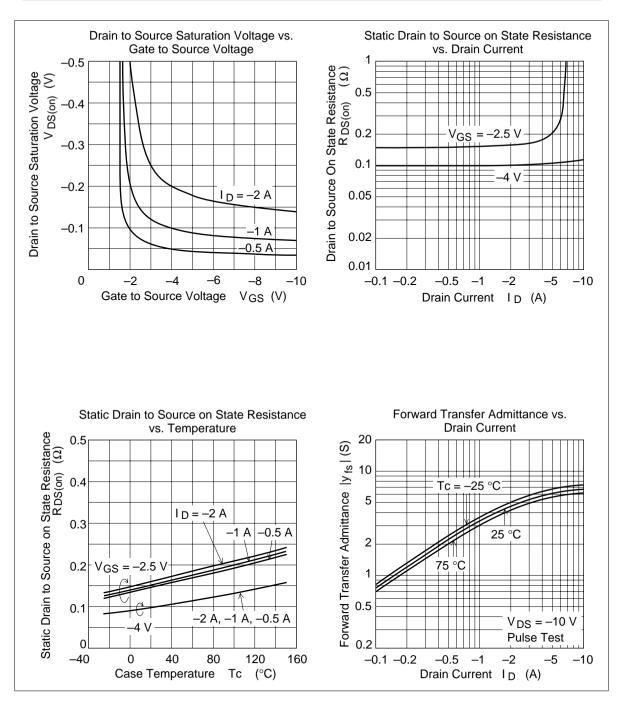
Electrical Characteristics (Ta = 25°C)

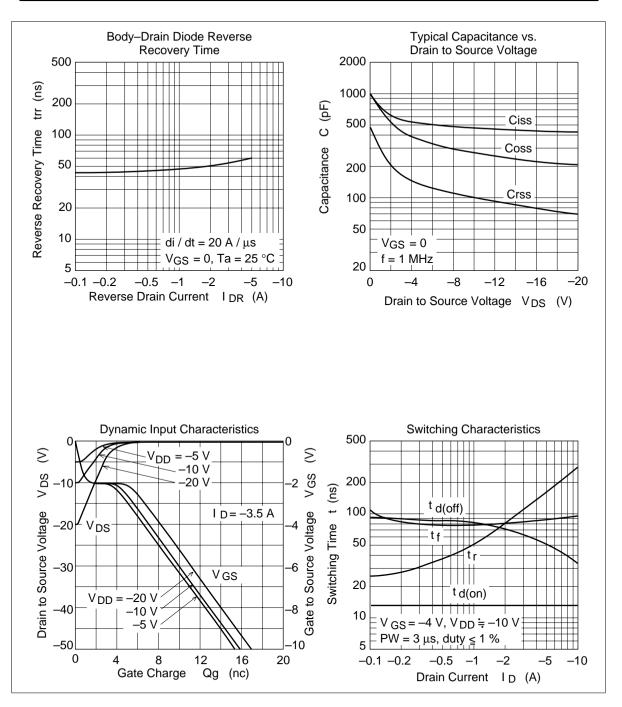
| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|--|-----------------------------|------|-------|-------|------|---|
| Drain to source breakdown voltage | $V_{(\text{BR})\text{DSS}}$ | -20 | — | — | V | $I_{\rm D} = -10$ mA, $V_{\rm GS} = 0$ |
| Gate to source breakdown voltage | $V_{(BR)GSS}$ | ±10 | — | — | V | $I_{\rm G}=\pm 100 \mu A, \ V_{\rm DS}=0$ |
| Gate to source leak current | I _{GSS} | — | | ±10 | μΑ | $V_{GS} = \pm 8V$, $V_{DS} = 0$ |
| Zero gate voltege drain current | I _{DSS} | | | -1 | μΑ | $V_{\rm DS} = -20$ V, $V_{\rm GS} = 0$ |
| Gate to source cutoff voltage | $V_{GS(off)}$ | -0.5 | | -1.5 | V | $V_{DS} = -10V, I_{D} = -1mA$ |
| Static drain to source on state | R _{DS(on)} | _ | 0.10 | 0.14 | Ω | $I_{\rm D} = -2A, V_{\rm GS} = -4V^{\rm Note4}$ |
| resistance | R _{DS(on)} | _ | 0.16 | 0.23 | Ω | $I_{\rm D} = -2A, V_{\rm GS} = -2.5V^{\rm Note4}$ |
| Forward transfer admittance | y _{fs} | 3 | 4.5 | _ | S | $I_{\rm D} = -2A, V_{\rm DS} = -10V^{\rm Note4}$ |
| Input capacitance | Ciss | _ | 465 | | pF | $V_{DS} = -10V$ |
| Output capacitance | Coss | _ | 270 | _ | pF | $V_{GS} = 0$ |
| Reverse transfer capacitance | Crss | _ | 100 | _ | pF | f = 1MHz |
| Turn-on delay time | t _{d(on)} | _ | 14 | _ | ns | $V_{GS} = -4V, I_D = -2A$ |
| Rise time | t, | _ | 80 | _ | ns | $V_{DD} \simeq -10V$ |
| Turn-off delay time | t _{d(off)} | _ | 70 | _ | ns | |
| Fall time | t _f | _ | 80 | _ | ns | |
| Body–drain diode forward voltage | V_{DF} | — | -0.95 | -1.24 | V | $IF=-3.5A,V_{GS}=0^{Note4}$ |
| Body–drain diode reverse recovery time | t _{rr} | — | 55 | _ | ns | $IF = -3.5A, V_{GS} = 0$ diF/ dt =20A/ μ s |
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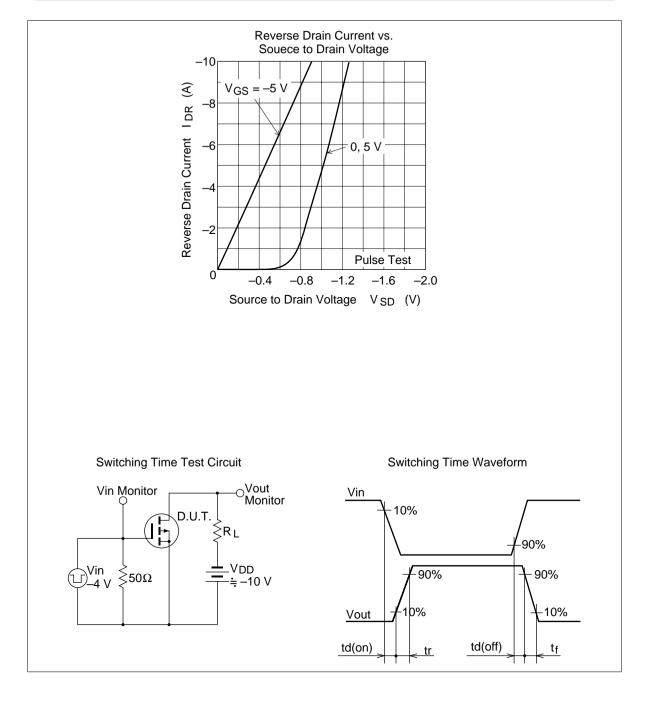
Note: 4. Pulse test

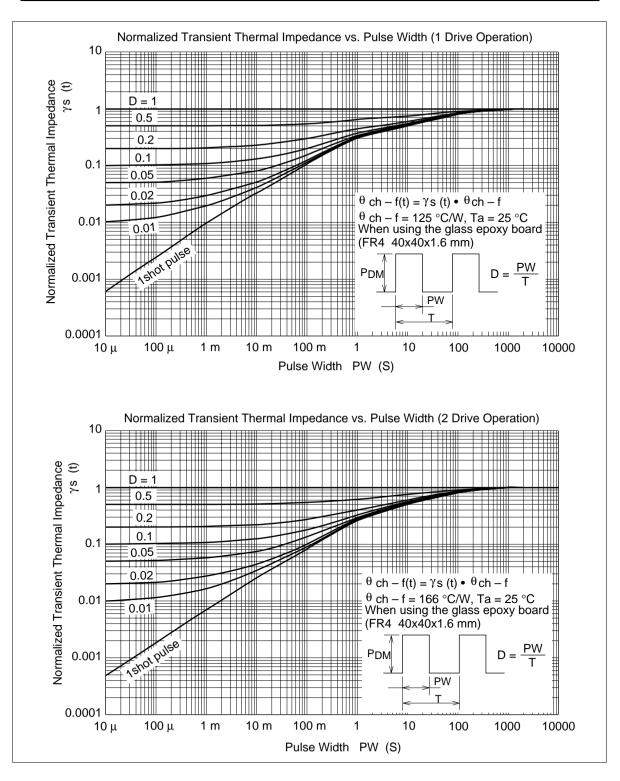
Main Characteristics



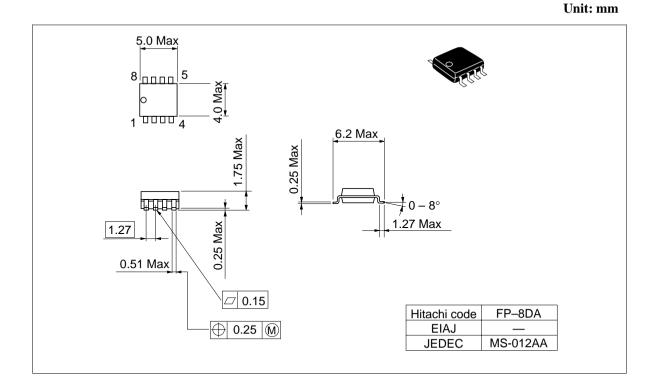








Package Dimensions



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